

# μPG2418TB

## GaAs Integrated Circuit 0.5 to 3.0 GHz SPDT Switch with 50 Ω Termination

 R09DS0007EJ0100  
 Rev.1.00  
 Aug 24, 2010

### DESCRIPTION

The μPG2418TB is a GaAs MMIC for L, S-band SPDT (Single Pole Double Throw) switch with 50 Ω termination for 2.4 GHz wireless LAN, mobile phone and other L, S-band applications.

This device operates with dual control switching voltages of 2.5 to 5.3 V. This device can operate at frequencies from 0.5 to 3.0 GHz, with low insertion loss and high isolation.

This device is housed in a 6-pin super minimold package (SC-88/SOT-363 type), and is suitable for high-density surface mounting.

### FEATURES

- Switch control voltage :  $V_{\text{cont (H)}} = 3.0 \text{ V TYP.}$   
:  $V_{\text{cont (L)}} = 0 \text{ V TYP.}$
- Low insertion loss :  $L_{\text{ins}} = 0.45 \text{ dB TYP. @ } f = 2.5 \text{ GHz}$
- High isolation :  $\text{ISL} = 21 \text{ dB TYP. @ } f = 2.5 \text{ GHz}$
- Handling power :  $P_{\text{in (0.1 dB)}} = +29.0 \text{ dBm TYP. @ } f = 0.5 \text{ to } 3.0 \text{ GHz}$
- High-density surface mounting : 6-pin super minimold package (SC-88/SOT-363 type) (2.0 × 1.25 × 0.9 mm)

### APPLICATIONS

- W-LAN and Bluetooth™ etc.
- L, S-band digital cellular or cordless telephone

### ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2418TB-E4	μPG2418TB-E4-A	6-pin super minimold (SC-88/SOT-363 type) (Pb-Free)	G6H	<ul style="list-style-type: none"> <li>• Embossed tape 8 mm wide</li> <li>• Pin 4, 5, 6 face the perforation side of the tape</li> <li>• Qty 3 kpcs/reel</li> </ul>

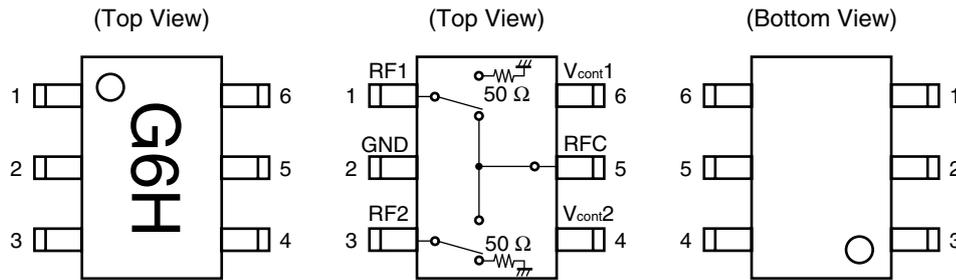
**Remark** To order evaluation samples, please contact your nearby sales office.

Part number for sample order: μPG2418TB

### CAUTION

Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.

**PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM**



Pin No.	Pin Name
1	RF1
2	GND
3	RF2
4	V <sub>cont2</sub>
5	RFC
6	V <sub>cont1</sub>

**SW TRUTH TABLE**

ON Path	V <sub>cont1</sub>	V <sub>cont2</sub>
RFC-RF1	High	Low
RFC-RF2	Low	High

**ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = +25°C, unless otherwise specified)**

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	V <sub>cont</sub>	+6.0 <sup>Note</sup>	V
Input Power (ON Port)	P <sub>in</sub>	+33.0	dBm
Input Power (OFF Port)	P <sub>in</sub>	+20.0	dBm
Operating Ambient Temperature	T <sub>A</sub>	-45 to +85	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C

Note: |V<sub>cont1</sub> - V<sub>cont2</sub>| ≤ 6.0 V

**RECOMMENDED OPERATING RANGE (T<sub>A</sub> = +25°C, unless otherwise specified)**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f	0.5	-	3.0	GHz
Switch Control Voltage (H)	V <sub>cont (H)</sub>	2.5	3.0	5.3	V
Switch Control Voltage (L)	V <sub>cont (L)</sub>	-0.2	0	0.2	V
Control Voltage Difference	ΔV <sub>cont (H)</sub> , ΔV <sub>cont (L)</sub> <sup>Note</sup>	-0.1	0	0.1	V

Note: ΔV<sub>cont (H)</sub> = V<sub>cont1 (H)</sub> - V<sub>cont2 (H)</sub>  
 ΔV<sub>cont (L)</sub> = V<sub>cont1 (L)</sub> - V<sub>cont2 (L)</sub>

**ELECTRICAL CHARACTERISTICS**

( $T_A = +25^{\circ}\text{C}$ ,  $V_{\text{cont (H)}} = 3.0\text{ V}$ ,  $V_{\text{cont (L)}} = 0\text{ V}$ ,  $Z_0 = 50\ \Omega$ , DC blocking capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	$L_{\text{ins}}$	f = 0.5 to 1.0 GHz	–	0.30	0.50	dB
		f = 1.0 to 2.0 GHz	–	0.37	0.57	dB
		f = 2.0 to 2.5 GHz	–	0.45	0.65	dB
		f = 2.5 to 3.0 GHz	–	0.50	0.70	dB
Isolation	ISL	f = 0.5 to 2.0 GHz	19	23	–	dB
		f = 2.0 to 2.5 GHz	17	21	–	dB
		f = 2.5 to 3.0 GHz	16	20	–	dB
Input Return Loss	$RL_{\text{in}}$	f = 0.5 to 3.0 GHz	15	20	–	dB
Output Return Loss	$RL_{\text{out}}$	f = 0.5 to 3.0 GHz	15	20	–	dB
Unused Port Return Loss	URL	f = 2.0 to 3.0 GHz	10	20	–	dB
0.1 dB Loss Compression Input Power <sup>Note1</sup>	$P_{\text{in (0.1 dB)}}$	f = 2.0/2.5 GHz	+26.0	+29.0	–	dBm
		f = 0.5 to 3.0 GHz	–	+29.0	–	dBm
1 dB Loss Compression Input Power <sup>Note2</sup>	$P_{\text{in (1 dB)}}$	f = 2.0/2.5 GHz	+29.0	+32.0	–	dBm
		f = 0.5 to 3.0 GHz	–	+32.0	–	dBm
Input 3rd Order Intercept Point	IIP <sub>3</sub>	f = 0.5 to 3.0 GHz, 2 tone, 5 MHz spacing	–	+60	–	dBm
Switch Control Current	$I_{\text{cont}}$	No RF input	–	0.3	20	μA
Switch Control Speed	$t_{\text{sw}}$	50% CTL to 90/10% RF	–	50	500	ns

Notes: 1.  $P_{\text{in (0.1 dB)}}$  is the measured input power level when the insertion loss increases 0.1 dB more than that of the linear range.

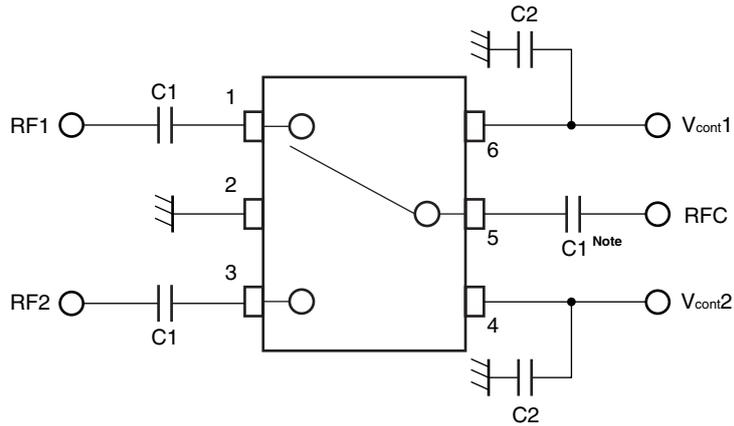
2.  $P_{\text{in (1 dB)}}$  is the measured input power level when the insertion loss increases 1 dB more than that of the linear range.

**CAUTION**

It is necessary to use DC blocking capacitors with this device.

The value of DC blocking capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system.

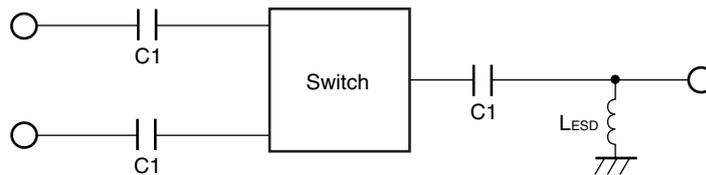
## EVALUATION CIRCUIT



Note: C1: 56 pF  
C2: 1 000 pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

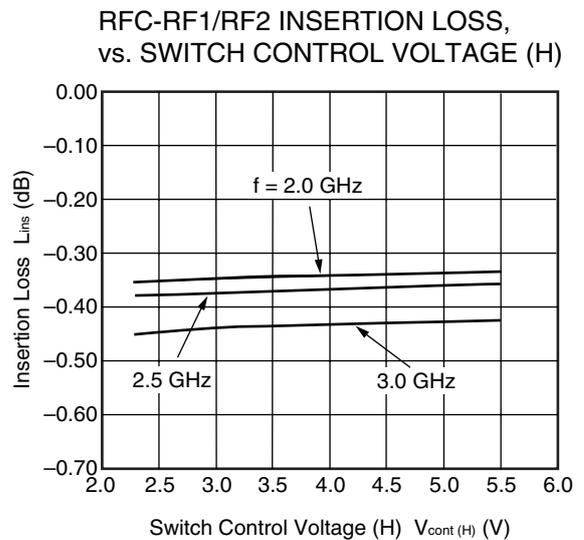
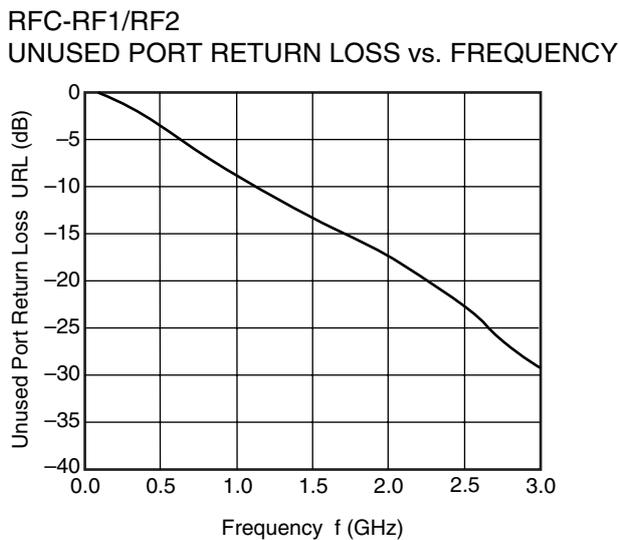
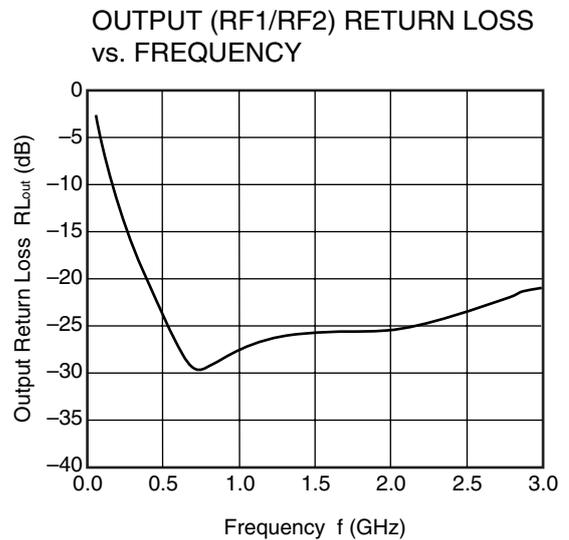
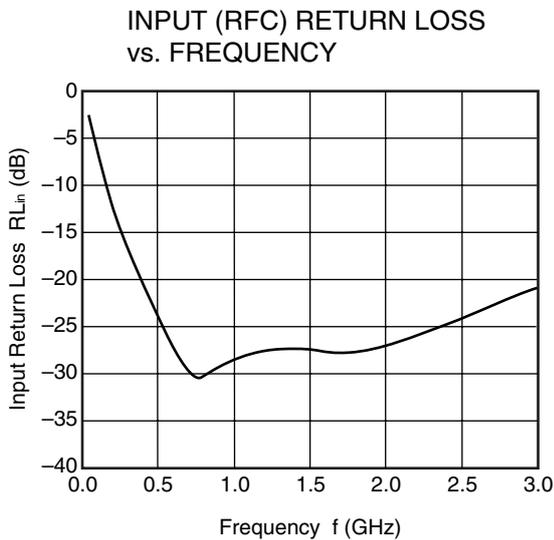
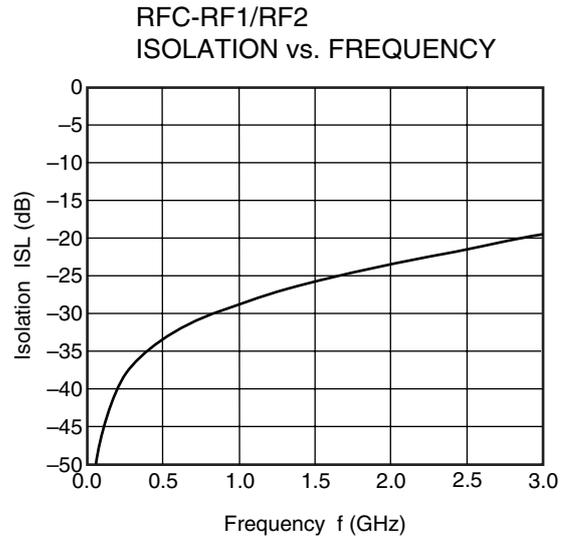
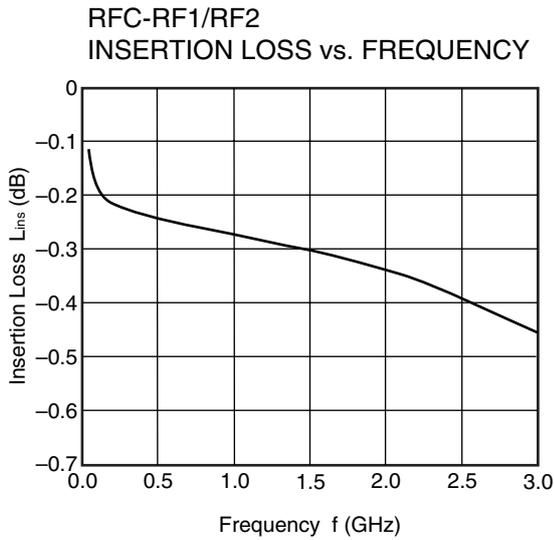
## APPLICATION INFORMATION



- $L_{ESD}$  provides a means to increase the ESD protection on a specific RF port, typically the port attached to the antenna.
- The value may be tailored to provide specific electrical responses.
- The RF ground connections should be kept as short as possible and connected to directly to a good RF ground for best performance.

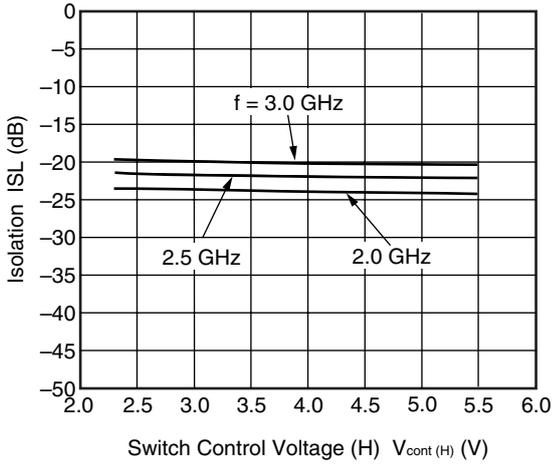
**TYPICAL CHARACTERISTICS**

( $T_A = +25^\circ\text{C}$ ,  $V_{\text{cont (H)}} = 3.0\text{ V}$ ,  $V_{\text{cont (L)}} = 0\text{ V}$ ,  $Z_O = 50\ \Omega$ , DC blocking capacitors = 56 pF, unless otherwise specified)

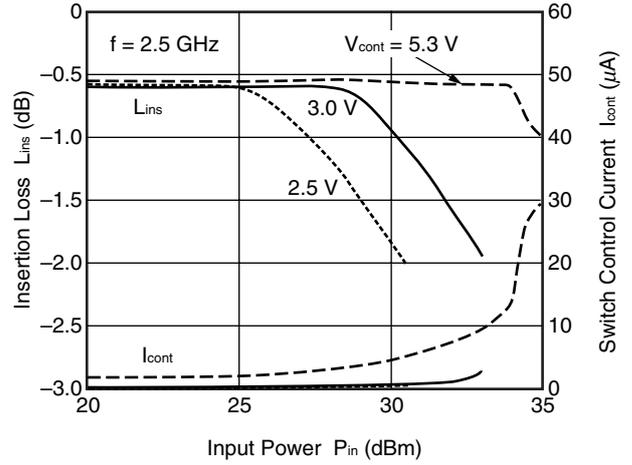


**Remark** The graphs indicate nominal characteristics.

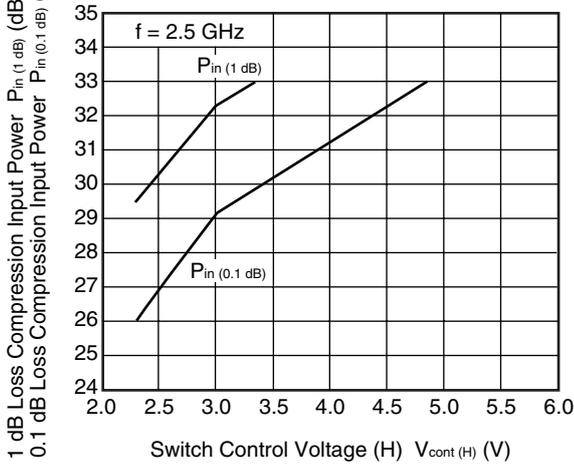
RFC-RF1/RF2 ISOLATION vs. SWITCH CONTROL VOLTAGE (H)



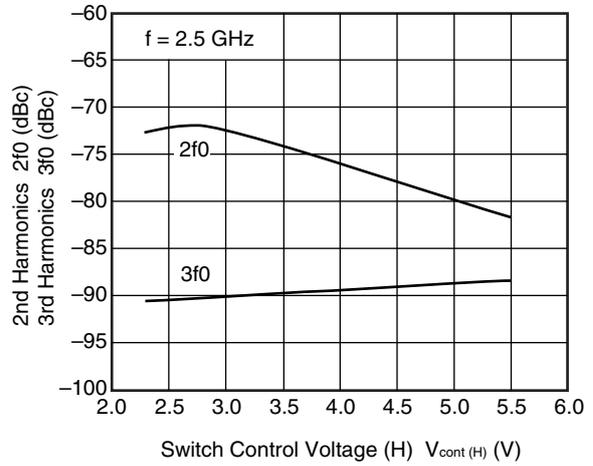
RFC-RF1/RF2 INSERTION LOSS,  $I_{cont}$  vs. INPUT POWER



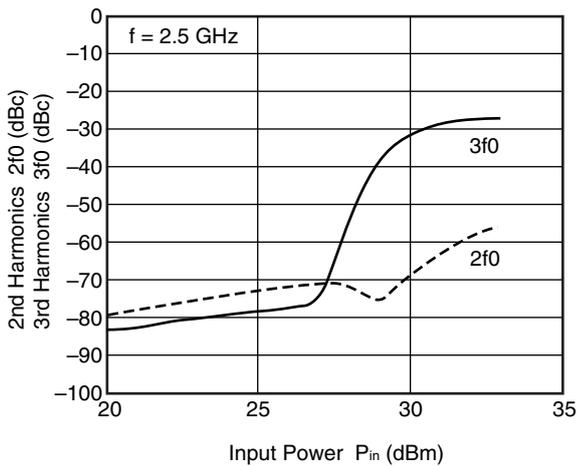
RFC-RF1/RF2  $P_{in}$  (1 dB),  $P_{in}$  (0.1 dB) vs. SWITCH CONTROL VOLTAGE (H)



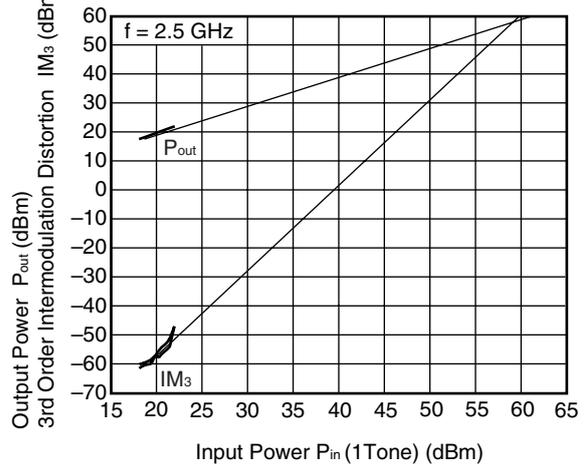
RFC-RF1/RF2 2f0, 3f0 vs. SWITCH CONTROL VOLTAGE (H)



RFC-RF1/RF2 2f0, 3f0 vs. INPUT POWER



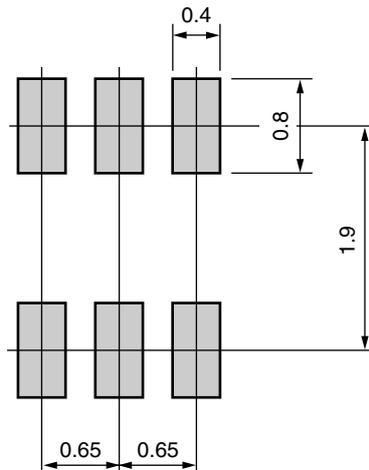
RFC-RF1/RF2 OUTPUT POWER,  $IM_3$  vs. INPUT POWER



**Remark** The graphs indicate nominal characteristics.

## MOUNTING PAD LAYOUT DIMENSIONS

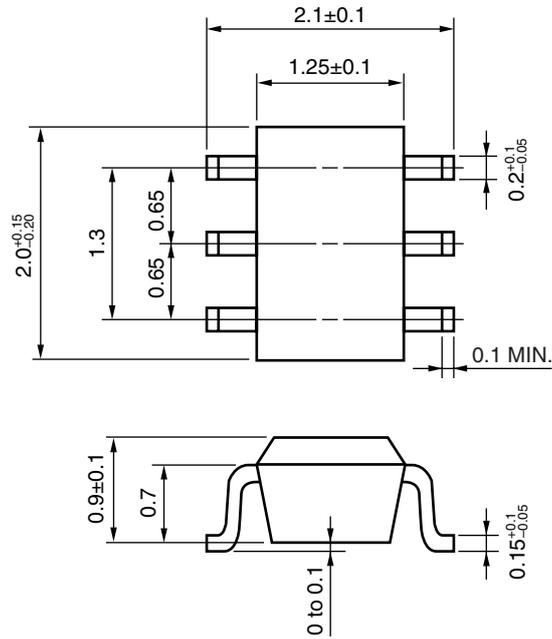
6-PIN SUPER MINIMOLD (SC-88/SOT-363 TYPE) (UNIT: mm)



**Remark** The mounting pad layout in this document is for reference only.  
When designing PCB, please consider workability of mounting, solder joint reliability, prevention of solder bridge and so on, in order to optimize the design.

## PACKAGE DIMENSIONS

6-PIN SUPER MINIMOLD (SC-88/SOT-363 TYPE) (UNIT: mm)



**RECOMMENDED SOLDERING CONDITIONS**

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

<b>Soldering Method</b>	<b>Soldering Conditions</b>	<b>Condition Symbol</b>
Infrared Reflow	Peak temperature (package surface temperature) : 260°C or below Time at peak temperature : 10 seconds or less Time at temperature of 220°C or higher : 60 seconds or less Preheating time at 120 to 180°C : 120±30 seconds Maximum number of reflow processes : 3 times Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) : 260°C or below Time at peak temperature : 10 seconds or less Preheating temperature (package surface temperature): 120°C or below Maximum number of flow processes : 1 time Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) : 350°C or below Soldering time (per side of device) : 3 seconds or less Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	HS350

**CAUTION**

Do not use different soldering methods together (except for partial heating).

<b>Caution</b>	GaAs Products	<p>This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none"><li>• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.<ol style="list-style-type: none"><li>1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li><li>2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li></ol></li><li>• Do not burn, destroy, cut, crush, or chemically dissolve the product.</li><li>• Do not lick the product or in any way allow it to enter the mouth.</li></ul>
----------------	---------------	--

<b>Revision History</b>	<b>μPG2418TB Data Sheet</b>
-------------------------	-----------------------------

Rev.	Date	Description	
		Page	Summary
1.00	Aug 24, 2010	–	First edition issued

Bluetooth is a trademark owned by Bluetooth SIG, Inc., U.S.A.

All trademarks and registered trademarks are the property of their respective owners.
---

## Notice

1. All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas Electronics products listed herein, please confirm the latest product information with a Renesas Electronics sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas Electronics such as that disclosed through our website.
2. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
3. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part.
4. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
5. When exporting the products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations. You should not use Renesas Electronics products or the technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations.
6. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
7. Renesas Electronics products are classified according to the following three quality grades: "Standard", "High Quality", and "Specific". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below. You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application categorized as "Specific" without the prior written consent of Renesas Electronics. Further, you may not use any Renesas Electronics product for any application for which it is not intended without the prior written consent of Renesas Electronics. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for an application categorized as "Specific" or for which the product is not intended where you have failed to obtain the prior written consent of Renesas Electronics. The quality grade of each Renesas Electronics product is "Standard" unless otherwise expressly specified in a Renesas Electronics data sheets or data books, etc.  
"Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots.  
"High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; safety equipment; and medical equipment not specifically designed for life support.  
"Specific": Aircraft; aerospace equipment; submersible repeaters; nuclear reactor control systems; medical equipment or systems for life support (e.g. artificial life support devices or systems), surgical implantations, or healthcare intervention (e.g. excision, etc.), and any other applications or purposes that pose a direct threat to human life.
8. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
9. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
11. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.  
(Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.  
(Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.



### SALES OFFICES

Renesas Electronics Corporation

<http://www.renesas.com>

Refer to "<http://www.renesas.com/>" for the latest and detailed information.

**Renesas Electronics America Inc.**  
2880 Scott Boulevard Santa Clara, CA 95050-2554, U.S.A.  
Tel: +1-408-588-6000, Fax: +1-408-588-6130

**Renesas Electronics Canada Limited**  
1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada  
Tel: +1-905-898-5441, Fax: +1-905-898-3220

**Renesas Electronics Europe Limited**  
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K  
Tel: +44-1628-585-100, Fax: +44-1628-585-900

**Renesas Electronics Europe GmbH**  
Arcadiastrasse 10, 40472 Düsseldorf, Germany  
Tel: +49-211-6503-0, Fax: +49-211-6503-1327

**Renesas Electronics (China) Co., Ltd.**  
7th Floor, Quantum Plaza, No.27 ZhichunLu Haidian District, Beijing 100083, P.R.China  
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

**Renesas Electronics (Shanghai) Co., Ltd.**  
Unit 204, 205, AZIA Center, No.1233 Lujiazui Ring Rd., Pudong District, Shanghai 200120, China  
Tel: +86-21-5877-1818, Fax: +86-21-6887-7858 / -7898

**Renesas Electronics Hong Kong Limited**  
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong  
Tel: +852-2886-9318, Fax: +852-2886-9022/9044

**Renesas Electronics Taiwan Co., Ltd.**  
7F, No. 363 Fu Shing North Road Taipei, Taiwan, R.O.C.  
Tel: +886-2-8175-9600, Fax: +886-2-8175-9670

**Renesas Electronics Singapore Pte. Ltd.**  
1 HarbourFront Avenue, #06-10, Keppel Bay Tower, Singapore 098632  
Tel: +65-6213-0200, Fax: +65-6278-8001

**Renesas Electronics Malaysia Sdn.Bhd.**  
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia  
Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

**Renesas Electronics Korea Co., Ltd.**  
11F, Samik Laviel'or Bldg., 720-2 Yeoksam-Dong, Kangnam-Ku, Seoul 135-080, Korea  
Tel: +82-2-558-3737, Fax: +82-2-558-5141